# UNISONIC TECHNOLOGIES CO., LTD

8NM45 Preliminary Power MOSFET

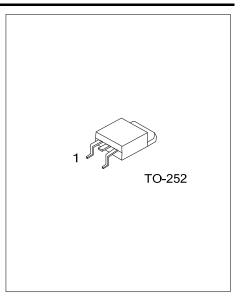
# 8.0A, 450V N-CHANNEL SUPER-JUNCTION MOSFET

#### ■ DESCRIPTION

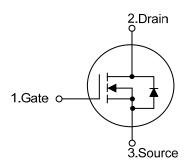
The UTC **8NM45** is a Super Junction MOSFET Structure and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and a high rugged avalanche characteristics. This power MOSFET is usually used at AC-DC converters for power applications.

#### **■ FEATURES0**

- \*  $R_{DS(ON)} \le 0.55 \Omega$  @  $V_{GS}$ =10V,  $I_D$ =4.0A
- \* Low on-resistance
- \* High Switching Speed
- \* 100% Avalanche Tested



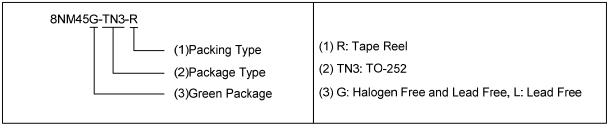
#### ■ SYMBOL



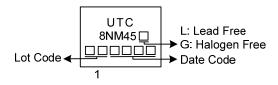
#### ■ ORDERING INFORMATION

Ordering Number		Daakana	Pin Assignment			Dooking	
Lead Free	Halogen Free	Package	1	2	3	Packing	
8NM45L-TN3-R	8NM45G-TN3-R	TO-252	G	D	S	Tape Reel	

Note: Pin Assignment: G: Gate D: Drain S: Source



#### ■ MARKING



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## ■ **ABSOLUTE MAXIMUM RATINGS** (T<sub>C</sub>=25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT	
Drain-Source Voltage		$V_{ t DSS}$	450	<b>&gt;</b>	
Gate-Source Voltage		$V_{GSS}$	±30	<b>&gt;</b>	
Drain Current	Continuous	I <sub>D</sub>	8	Α	
	Pulsed (Note 2)	I <sub>DM</sub>	24	Α	
Avalanche Energy	Single Pulsed (Note 3)	E <sub>AS</sub>	324	mJ	
Peak Diode Recovery dv/dt (Note 4)		dv/dt	3.7	V/ns	
Power Dissipation		$P_{D}$	27	W	
Junction Temperature		TJ	+150	°C	
Storage Temperature		T <sub>STG</sub>	-55 ~ <b>+</b> 150	°C	

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 3. L = 144mH,  $I_{AS}$  = 2.1A,  $V_{DD}$  = 50V,  $R_{G}$  = 25  $\Omega$ , Starting  $T_{J}$  = 25°C
- 4.  $I_{SD} \le 8.0$ A, di/dt  $\le 200$ A/ $\mu$ s,  $V_{DD} \le BV_{DSS}$ , Starting  $T_J = 25$ °C

### **■ THERMAL DATA**

PARAMETER	SYMBOL	RATING	UNIT	
Junction to Ambient	$\theta_{JA}$	110	°C/W	
Junction to Case	$\theta_{JC}$	4.63	°C/W	

Note: Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

## ■ **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub>=25°C, unless otherwise specified)

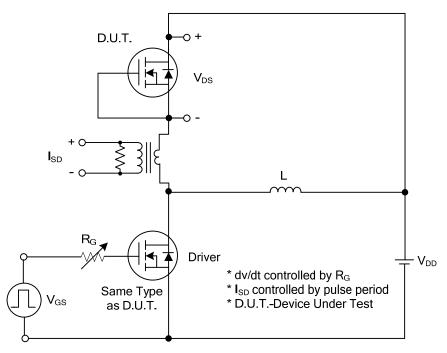
PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS}$ =0V, $I_D$ =250 $\mu$ A				V
Drain-Source Leakage Current	$I_{DSS}$	V <sub>DS</sub> =450V, V <sub>GS</sub> =0V			10	μΑ
Gate-Source Leakage Current	$I_{GSS}$	$V_{GS}$ =±30V, $V_{DS}$ =0V			±100	nΑ
ON CHARACTERISTICS						
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{DS}=V_{GS}$ , $I_{D}=250\mu A$	2.5		4.5	V
Static Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	$V_{GS}$ =10V, $I_{D}$ =4.0A			0.55	Ω
DYNAMIC CHARACTERISTICS						
Input Capacitance	$C_{ISS}$			317		pF
Output Capacitance	Coss	$V_{DS}$ =50V, $V_{GS}$ =0V, f=1MHz		190		pF
Reverse Transfer Capacitance	$C_{RSS}$			19		pF
SWITCHING CHARACTERISTICS						
Total Gate Charge (Note 1)	$Q_G$	V <sub>DS</sub> =50V, V <sub>GS</sub> =10V, I <sub>D</sub> =4.0A (Note 1, 2)		21		nC
Gate-Source Charge	$Q_GS$			6		nC
Gate-Drain Charge	$Q_GD$			10		nC
Turn-On Delay Time (Note 1)	t <sub>D(ON)</sub>			8		ns
Turn-On Rise Time	$t_{R}$	V <sub>DD</sub> =100V, V <sub>GS</sub> =10V,		24		ns
Turn-Off Delay Time	$t_{D(OFF)}$	I <sub>D</sub> =8.0A, R <sub>G</sub> =25Ω (Note 1, 2)		45		ns
Turn-Off Fall Time	t <sub>F</sub>			22		ns
SOURCE- DRAIN DIODE RATINGS AND CHA	ARACTERIST	ICS				
Maximum Continuous Drain-Source Diode	Is				8	Α
Forward Current	IS				0	^
Maximum Pulsed Drain-Source Diode	$I_{SM}$				24	Α
Forward Current	ISM				24	^
Drain-Source Diode Forward Voltage (Note 1)	$V_{SD}$	I <sub>S</sub> =8.0A, V <sub>GS</sub> =0V			1.4	V
Body Diode Reverse Recovery Time (Note 1)	t <sub>rr</sub>	I <sub>S</sub> =8.0A, V <sub>GS</sub> =0V,		216		nS
Body Diode Reverse Recovery Charge	$Q_{rr}$	dI <sub>F</sub> /dt=100A/μs		1.9		$\mu$ C

Notes: 1. Pulse Test: Pulse width  $\leq$  300µs, Duty cycle  $\leq$  2%.

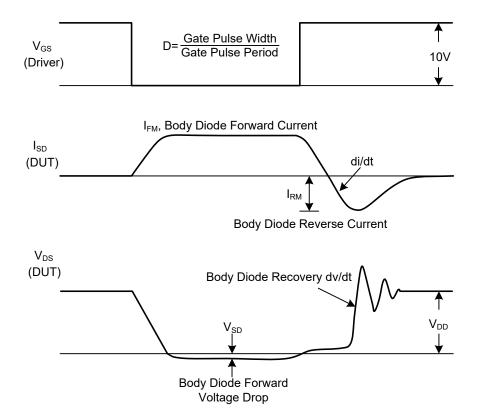
2. Essentially independent of operating temperature.



### **■ TEST CIRCUITS AND WAVEFORMS**

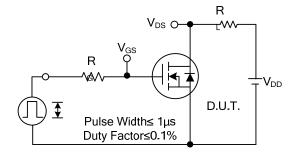


Peak Diode Recovery dv/dt Test Circuit

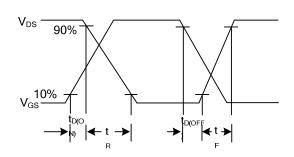


Peak Diode Recovery dv/dt Waveforms

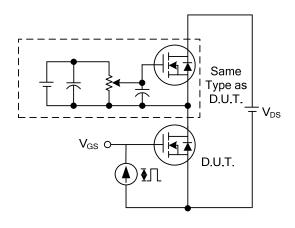
## **■ TEST CIRCUITS AND WAVEFORMS**



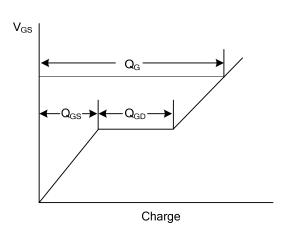
**Switching Test Circuit** 



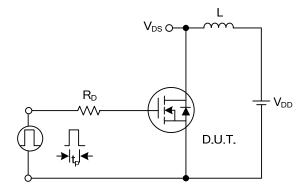
Switching Waveforms



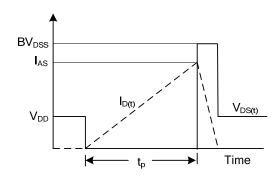
Gate Charge Test Circuit



Gate Charge Waveform



Unclamped Inductive Switching Test Circuit



Unclamped Inductive Switching Waveforms

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